

## Electronic Patent Application Fee Transmittal

Application Number:	10807527			
Filing Date:	24-Mar-2004			
Title of Invention:	Land grid array packaged device and method of forming same			
First Named Inventor/Applicant Name:	Hei Ming Shiu			
Filer:	Charles Edward Bergere/Jeslyn Goh			
Attorney Docket Number:	SC13154HP			
Filed as Large Entity				
<b>Utility Filing Fees</b>				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
Filing a brief in support of an appeal	1402	1	500	500
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>500</b>